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Renesas Electronics Corporation

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H8/300H Tiny Series

Conversion from Five-Digit BCD to Two-Byte Hexadecimal (BCD)

Introduction

Converts the three-byte five-digit BCD (binary coded decimal) number set in general registers to a two-byte hexadecimal number, and places the result in another general register.

Target Device

H8/300H Tiny Series

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1. Function

1. Converts a three-byte five-digit BCD (binary coded decimal) number in general registers to two-byte hexadecimal, and places the result in another general register.
2. Data operations are entirely on the general registers.
3. The maximum acceptable five-digit BCD number is D'65535.

2. Arguments

Contents		Storage Location	Data Length (Bytes)
Input	5-digit BCD number (highest-order digit)	R0L	1
	5-digit BCD number (4 lower-order digits)	R1	2
Output	2-byte hexadecimal number	R2	2

3. Changes to Internal Registers and Flags

	31	16	15	8	7	0
ER0				Digit counter		5-digit BCD number (highest digit)
ER1				5-digit BCD (4 lower digits)		
ER2				2-byte hexadecimal number		
ER3				Work		
ER4						
ER5						Work
ER6						Work
ER7 (SP)						

I	UI	H	U	N	Z	V	C
—	—	↓	—	↓	↓	↓	↓

—: No change
 ↓: Varies
 0: Fixed to 0
 1: Fixed to 1

4. Programming Specifications

	Program memory (bytes)
	64
	Data memory (bytes)
	0
	Stack (bytes)
	2
	Number of cycles
	210
	Re-entrant
	Yes
	Relocatable
	Yes
	Interrupts during execution
	Yes

5. Description

5.1 Description of Functions

- The arguments are as follows.

R0L: Set the highest-order digit (byte) of the five-digit BCD number as part of the input argument.

R1: Set the lower-order four digits (two bytes) of the BCD number as part of the input argument.

R2: The two-byte hexadecimal number is set here as the output argument.

Figure 1 shows the format of the input and output arguments.

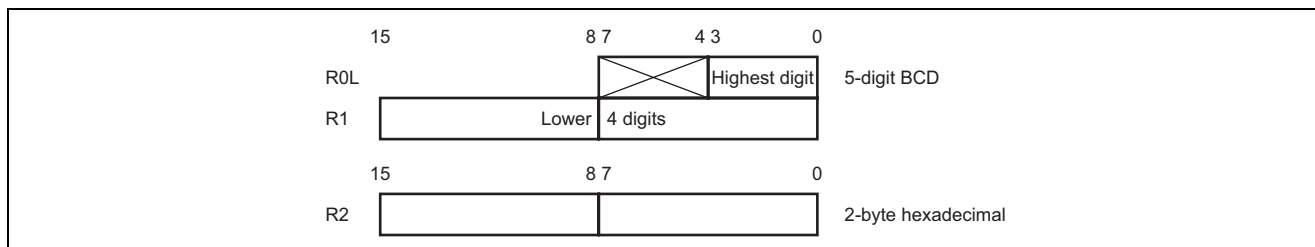


Figure 1 Input and Output Arguments

- Figure 2 illustrates the execution of the BCD subroutine. When the input argument is set as shown below, the subroutine sets the corresponding two-byte hexadecimal number in R2.

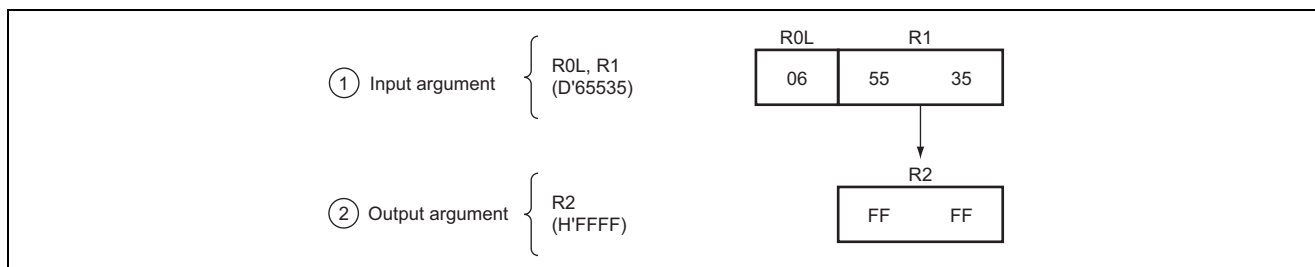


Figure 2 Example of BCD Execution

5.2 Usage Notes

- The values of bits 4 to 7 in R0L, which hold the highest-order digit of the five-digit BCD number, are not converted and are cleared to "0", regardless of their initial value, by the execution of this subroutine.
- D'65535 is thus the highest possible five-digit BCD number.
- Any higher-order digits of the five-digit BCD number that are not used must be explicitly set to "0". If this is not done, the correct result might not be obtained because undefined data in the higher-order digits is included in the operation.

5.3 Description of Data Memory

No data memory is used by BCD.

5.4 Example of Usage

After setting the five-digit BCD number as an input argument, call the BCD subroutine.

```

WORK1 . RES. B 3      ..... Reservation of the data memory area for setting of the 5-digit BCD number (3 bytes) by the
                           user program.
WORK2 . RES. B 2      ..... Reservation of the data memory area where the 2-byte hexadecimal number will be set for
                           the user program.
      .
      .
      .
      MOV. B @WORK1, R0L ..... Sets, as the input argument, the 5-digit BCD number specified by the user program.

      MOV. B @WORK1+1, R1H

      MOV. B @WORK1+2, R1L

      JSR @BCD          ..... Subroutine call of BCD.

      MOV. B R2H, @WORK2 ..... Transfers the 2-byte hexadecimal number set as the output argument to the data memory area
                           of the user program.
      MOV. B R2L, @WORK2+1
      .
      .
      .

```

5.5 Principles of Operation

1. The BCD subroutine has two sequences of processing.
 - 1) Extraction of the individual digits from the five-digit BCD number.
 - 2) Conversion of the extracted data to hexadecimal in four-bit units.
2. The processing of one digit (four bits) of input data is described below with reference to figure 3.

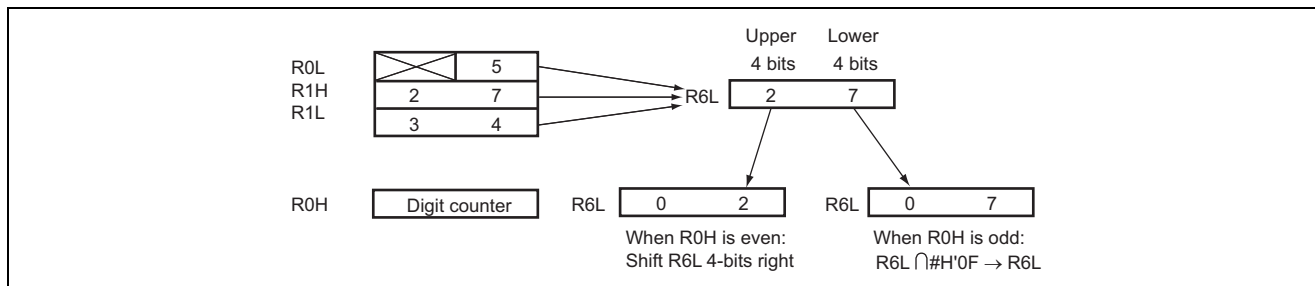


Figure 3 Dividing One Byte of Data in a General Register in Two

The BCD subroutine

- 1) sets H'04 in R0H to count the execution of processing for five digits;
- 2) transfers the current byte from the five-digit BCD number (R0L, R1H, R1L) to R6L in sequence from the highest-order byte;
- 3) decrements R0H.
- 4) selects the higher-order or lower-order four bits of that byte on the basis of whether the counter value is even or odd:
 - when R0H is odd, takes the logical AND of R6L and H'0F to extract the four lower-order bits,
 - when R0H is even, shifts R6L four bits to the right to extract the four higher-order bits; and

3. BCD-to-hexadecimal conversion is carried out in the following way.

1) A four-digit BCD number given as $D_3D_2D_1D_0$ may be expressed as shown below.

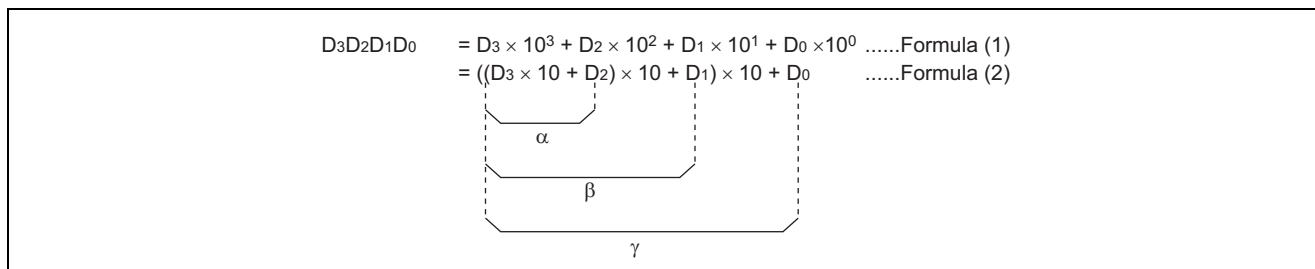


Figure 4 Concept of the Four-Digit BCD Number $D_3D_2D_1D_0$

2) Formula (2) in the above figure tells us that a four-digit BCD number can be converted to hexadecimal by finding

$\alpha = D_3 \times 10 + D_2$; and then calculating $\beta = \alpha \times 10 + D_1$ and $\gamma = \beta \times 10 + D_0$.

3) $D_3 \times 10$ can be calculated by the following formulae (3) and (4).

$D_3 \times 10 = D_3 \times (2 + 8)$ Formula (3)

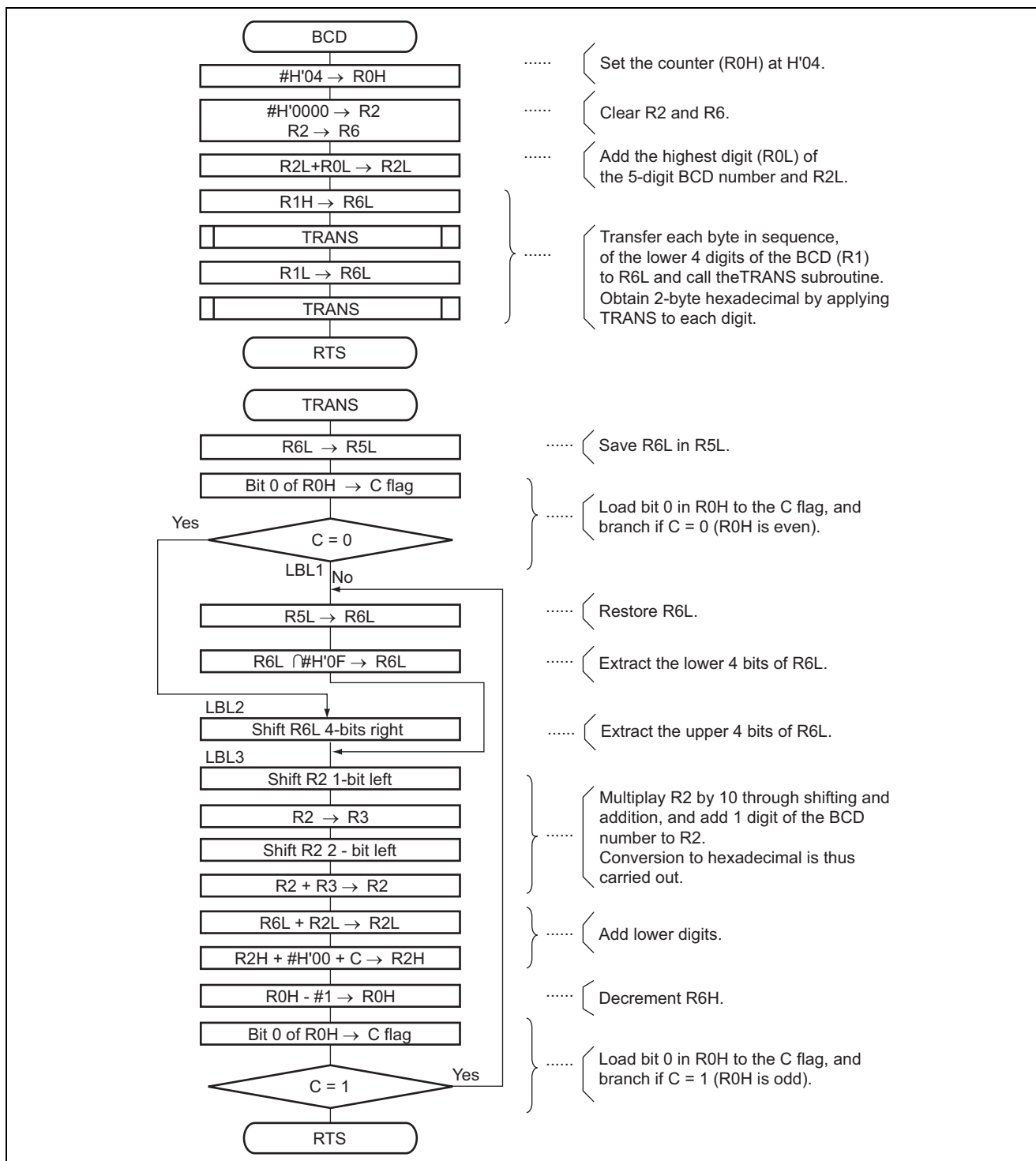
$= D_3 \times 2 \times (1 + 2^2)$ Formula (4)

4) In the BCD subroutine, formula (4) is implemented by using R2 and R3 in the following steps.

- a. D_3 is set in R2 and then shifted 1-bit left.
- b. R2 is transferred to R3 and then shifted two-bits left.
- c. R3 is added to R2.

4. The two-byte hexadecimal number is obtained by repeating the above steps, 2 and 3, five times.

6. Flowchart



7. Program Listing

```

1          1          ;*****
2          2          ;*
3          3          ;*      NAME : CHANGE 5 DIGIT BCD
4          4          ;*      TO 2 BYTE HEXADECEMAL
5          5          ;*
6          6          ;*****
7          7          ;*
8          8          ;*      ENTRY: R0L      (HIGHEST DIGIT (BCD))
9          9          ;*      R1      (LOWER 4 DIGITS (BCD))
10         10         ;*
11         11         ;*      RETURN: R2      (2 BYTE HEXADECEMAL)
12         12         ;*
13         13         ;*****
14         14         ;
15         15         .CPU      300HN
16         16         .SECTION  BCD_code, CODE, ALIGN=2
17         17         .EXPORT   BCD
18         18         ;
19         19         BCD      .EQU      $      ;Entry point
20         20         MOV.B     #H'04,R0H      ;Set bit counter
21         21         MOV.W     #H'0000,R2      ;Clear R2
22         22         MOV.W     R2,R6          ;Clear R6
23         23         ;
24         24         ADD.B     R0L,R2L        ;R2L + R0L -> R2L
25         25         MOV.B     R1H,R6L        ;R1H -> R6L
26         26         BSR       TRANS
27         27         MOV.B     R1L,R6L        ;R1L -> R6L
28         28         BSR       TRANS
29         29         RTS
30         30         ;
31         31         ;-----
32         32         ;
33         33         TRANS
34         34         MOV.B     R6L,R5L        ;R6L -> R5L
35         35         BLD       #0,R0H        ;Load bit 0 of R0H
36         36         BCC       LBL2          ;Branch if C=0
37         37         LBL1
38         38         MOV.B     R5L,R6L        ;R5L -> R6L
39         39         AND.B     #H'0F,R6L      ;Clear bit 7-4 of R6L
40         40         BRA       LBL3          ;Branch always
41         41         LBL2
42         42         SHLR.B     R6L           ;Shift R6L 4 bits left
43         43         SHLR.B     R6L
44         44         SHLR.B     R6L
45         45         SHLR.B     R6L
46         46         LBL3
47         47         SHLL.B     R2L           ;Shift hexadecimal 1 bit left
48         48         ROTXL.B   R2H
49         49         MOV.W     R2,R3          ;R2 -> R3
50         50         SHLL.B     R2L           ;Shift hexadecimal 2 bit left
51         51         ROTXL.B   R2H
52         52         SHLL.B     R2L

```

53	0034 1202	53	ROTXL.B	R2H	
54	0036 0932	54	ADD.W	R3,R2	;R3 + R2 -> R2
55	0038 08EA	55	ADD.B	R6L,R2L	
56	003A 9200	56	ADDX.B	#0,R2H	
57	003C 1A00	57	DEC.B	R0H	;Decrement bit counter
58	003E 7700	58	BLD	#0,R0H	;Load bit 0 of R0H
59	0040 45D8	59	BCS	LBL1	;Branch if C=1
60	0042 5470	60	RTS		
61		61			;
62		62	.END		
*****TOTAL ERRORS		0			
*****TOTAL WARNINGS		0			

Revision Record

Rev.	Date	Description	
		Page	Summary
2.00	Feb.28.06	—	Format has been changed from Hitachi version to Renesas version.

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